





High Power Single Chip LED

APG2C1-850 is a GaAlAs based, high power 850 nm single chip LED in standard emitter package for general application.

Specifications

- Structure: GaAlAs
- Peak Wavelength: 850 nm
- Optical Output Power: typ. 85 mW
- Life Time: > 10.000 hours
- Lead free product RoHS compliant



Absolute Maximum Ratings (T _a =25°C)					
Parameter	Symbol	Value	Unit		
Power Dissipation, DC	PD	1000	mW		
Forward Current, DC	I _F	500	mA		
Pulsed Current (1% duty cycle, 1kHz)	I _{FP}	1000	mA		
Reverse Voltage	U _R	-5	V		
Operating Temperature	T _{opr}	-30 +70	O°		
Storage Temperature	T _{stg}	-30 +85	°C		
Soldering Temperature (max. 1,5 s)	T _{sol}	330	C°		

Electro-Optical Characteristics (T_a=25°C)

Symbol	Condition	Min.	Тур.	Max.	Unit	
I _F		-	350	-	mA	
φ	I _F = 350 mA	-	± 75	-	deg.	
Po	I _F = 350 mA	-	85	-	mW	
λ _P	I _F = 350 mA	-	850	-	nm	
U _F	I _F = 350 mA	-	1.5	-	V	
Δλ	I _F = 350 mA	-	32	-	nm	
t _r	l _F = 350 mA		40		ns	
t _f	l _F = 350 mA		40		ns	
	Ι _F φ Ρ _Ο λ _Ρ U _F	$\begin{array}{c c} I_{F} & \\ \hline \phi & I_{F} = 350 \text{ mA} \\ \hline P_{O} & I_{F} = 350 \text{ mA} \\ \hline \lambda_{P} & I_{F} = 350 \text{ mA} \\ \hline U_{F} & I_{F} = 350 \text{ mA} \\ \hline \Delta \lambda & I_{F} = 350 \text{ mA} \\ \hline t_{r} & I_{F} = 350 \text{ mA} \\ \hline t_{f} & I_{F} = 350 \text{ mA} \\ \hline \end{array}$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	

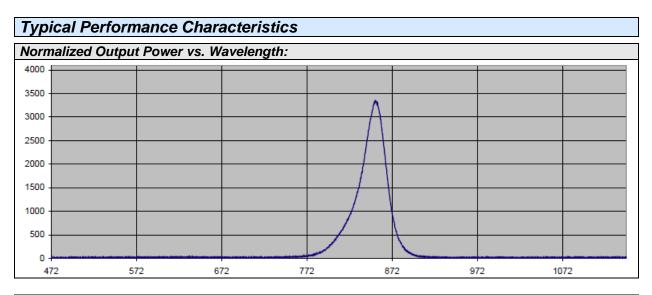
Wavelength measurements tolerance is +/- 2% Output power measurement tolerance is +/- 10%

Voltage measurement tolerance is +/- 2%

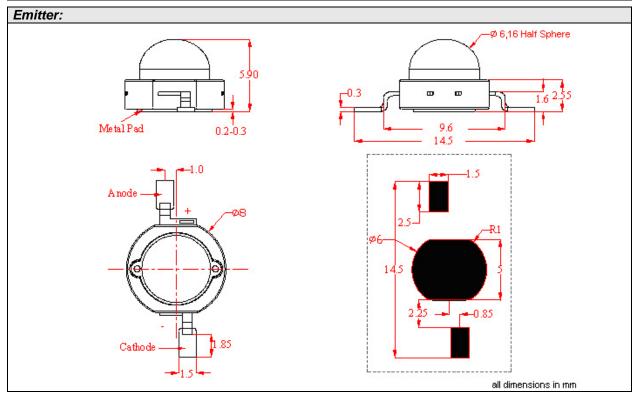
Device Materials

Item	Material	Lens		
Foundation	Plastic			
Lens	Acryl			
Electrodes	AgCu	Foundation		
Heat Sink	AgCu	Electrode		



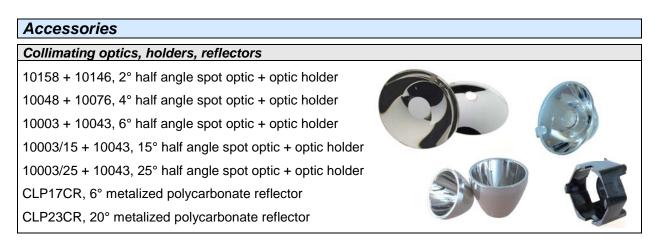


Outline Dimensions





Radiation Pattern (lambertian lens without optics) Relative Intensity vs. Angular Displacement 100 90 80 (%) 70 Relative Intensity 60 50 40 30 20 10 0 -100 -80 -60 -40 -20 0 20 40 60 80 100 Angular Displacement (Degrees)



Static Electricity

LEDs are very sensitive to static Electricity and surge voltage. It is recommended to wear a wristband or an anti-electrostatic glove whenever handling the LEDs

All devices, equipment, and machinery that is used when handling the LEDs must be grounded properly.



Heat Generation

It is advised to operate these LEDs at a reasonable low temperature for long lifetime and stability. High operating temperature will result in premature degradation and shortened lifetime.





Soldering Conditions

Reflow Soldering:

APG2C1 LEDs have a maximum storage temperature of 85°. Therefor it is not possible to use a reflow soldering process for array assembly!

Hot Bar Soldering:

A Hot Bar Soldering process is recommended when soldering APG2C1 emitters. This process will only transfer heat to the leads and avoids overheating the emitter which will damage the device. In order to transfer sufficient heat from the hot bar to the device, following parameters must be carefully considered:

- Amount of flux
- Pressing force of solder tip
- Hot bar temperature

For the standard assembly process, following parameters should be maintained:

- Hot Bar temperature: 330 °C
- Force of Hot Bar. 40 N
- Soldering time: 1.5 s

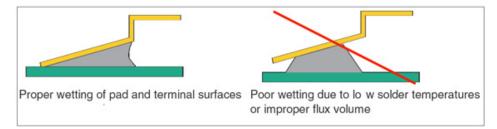
It is recommended to use a copper nickel-plated hot bar mounted to standard temperature controlled soldering equipment.

Manual Hand Soldering:

For prototype build or small series production runs, it is possible to place and solder the emitters by hand. It is therefore recommended to maintain the following parameters:

- Solder Tip Temperature 330 °C
- Soldering time. < 1.5 s
- Junction temperature must be kept below 70 °C

A visual inspection may be used to check the quality of the solder joint



General Soldering Precautions:

- Mechanical stress, shock and vibration must be avoided during soldering
- Only use non corrosive flux.
- Do not apply current to the device until it has cooled down to room temperature after soldering.

